



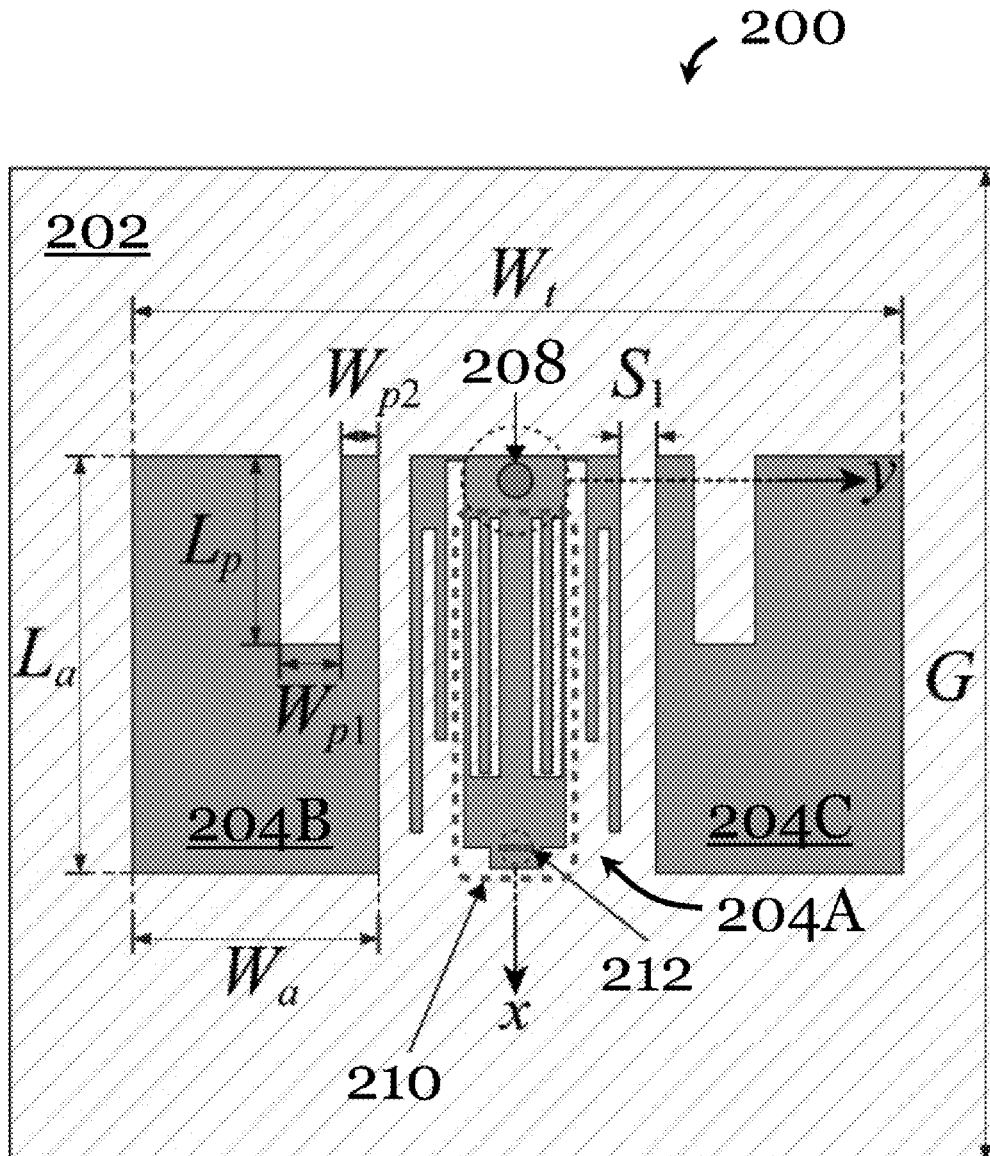
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(19) **United States**(12) **Patent Application Publication****Leung et al.**(10) **Pub. No.: US 2021/0119342 A1**(43) **Pub. Date: Apr. 22, 2021**(54) **FILTER-ANTENNA AND METHOD FOR MAKING THE SAME***H01Q 19/00* (2006.01)*H01Q 9/30* (2006.01)*H01Q 1/48* (2006.01)(71) Applicant: **City University of Hong Kong,**
Kowloon (HK)(52) **U.S. Cl.**CPC *H01Q 17/00* (2013.01); *H01Q 9/045*(2013.01); *H01Q 1/48* (2013.01); *H01Q 9/30*(2013.01); *H01Q 19/005* (2013.01)(72) Inventors: **Kwok Wa Leung,** Kowloon Tong
(HK); **Yan Ting Liu,** Kowloon (HK);
Nan Yang, Kowloon (HK)(21) Appl. No.: **16/658,388**

(57)

ABSTRACT(22) Filed: **Oct. 21, 2019****Publication Classification**(51) **Int. Cl.***H01Q 17/00* (2006.01)*H01Q 9/04* (2006.01)

A filter-antenna and a method for making a filter-antenna. The filter antenna includes a microstrip antenna, such as a patch antenna, integrated with an absorptive (e.g., bandstop) filter for absorbing or dissipating energy.



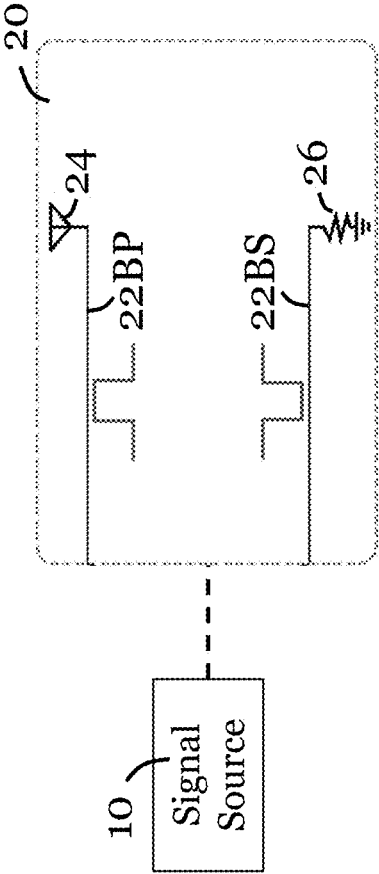


Figure 1

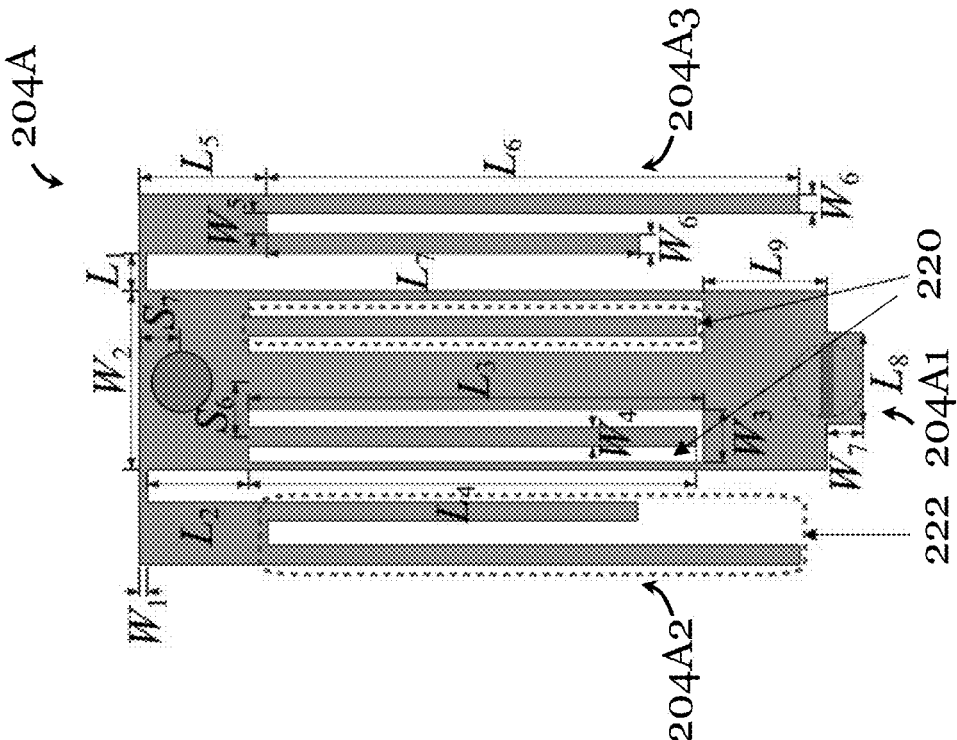


Figure 2A

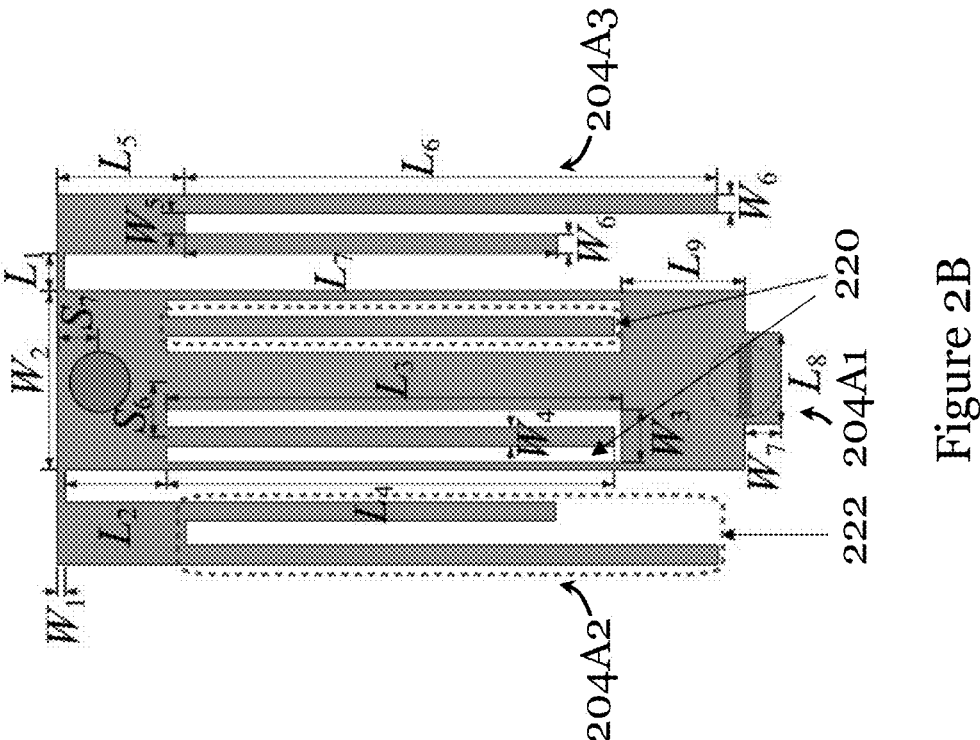


Figure 2B

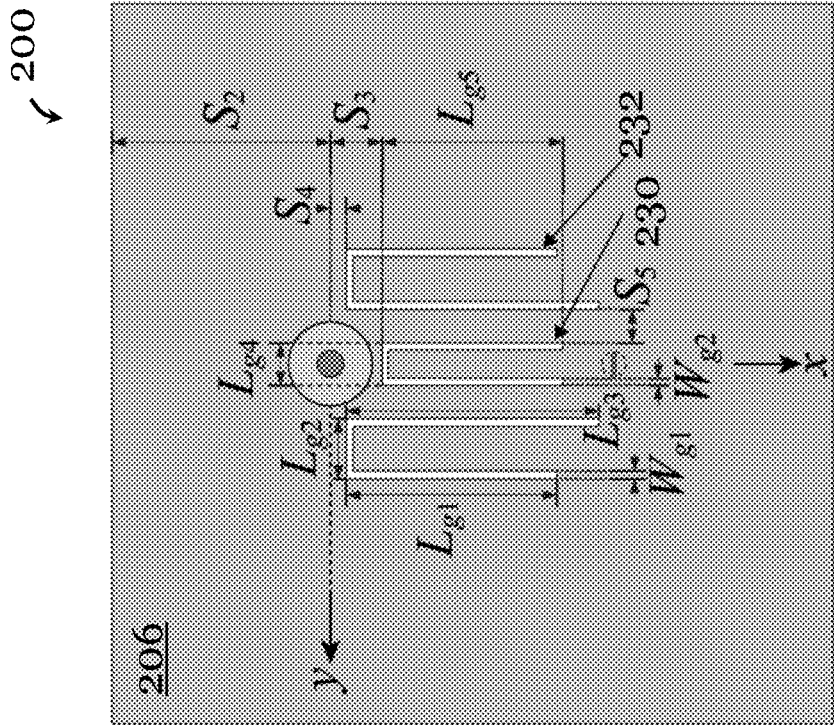


Figure 2D

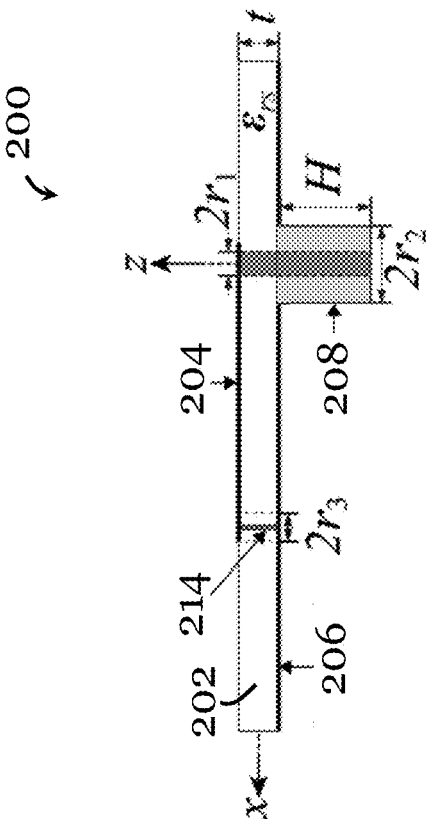


Figure 2C

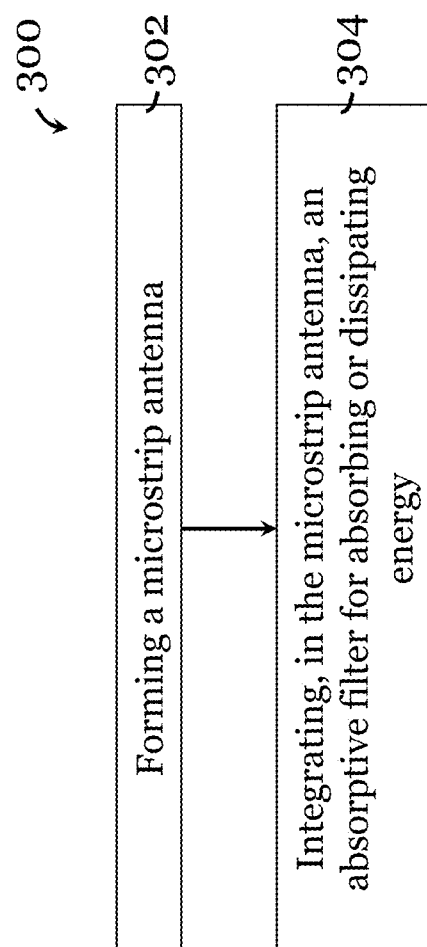


Figure 3

↙ 400

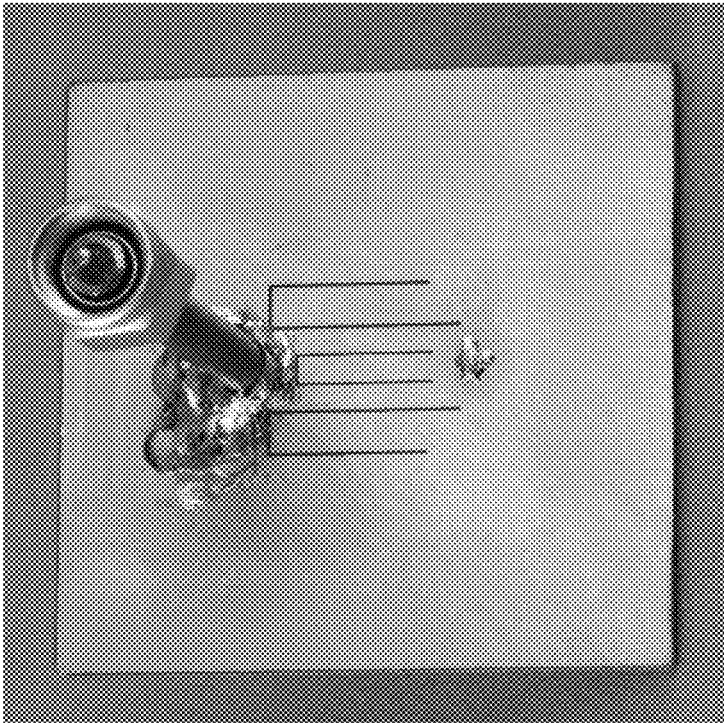


Figure 4B

↙ 400

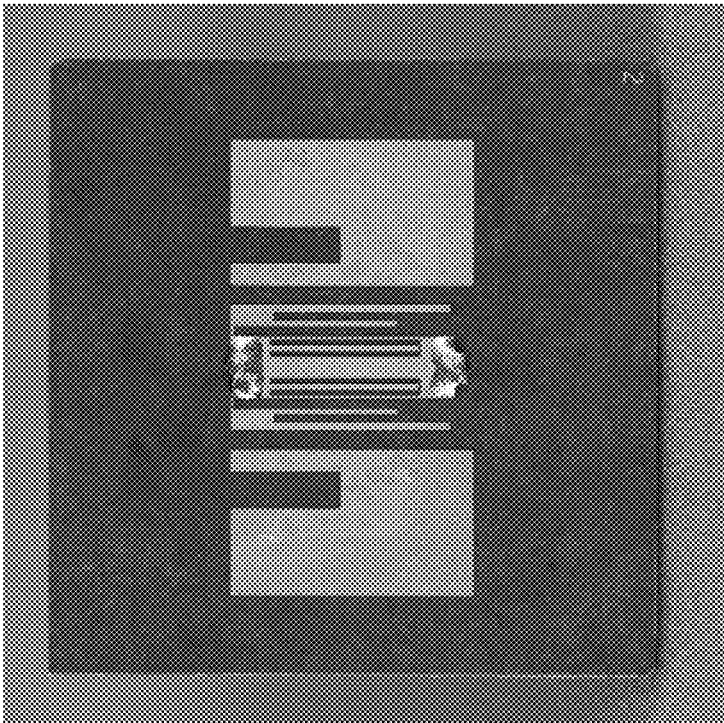


Figure 4A

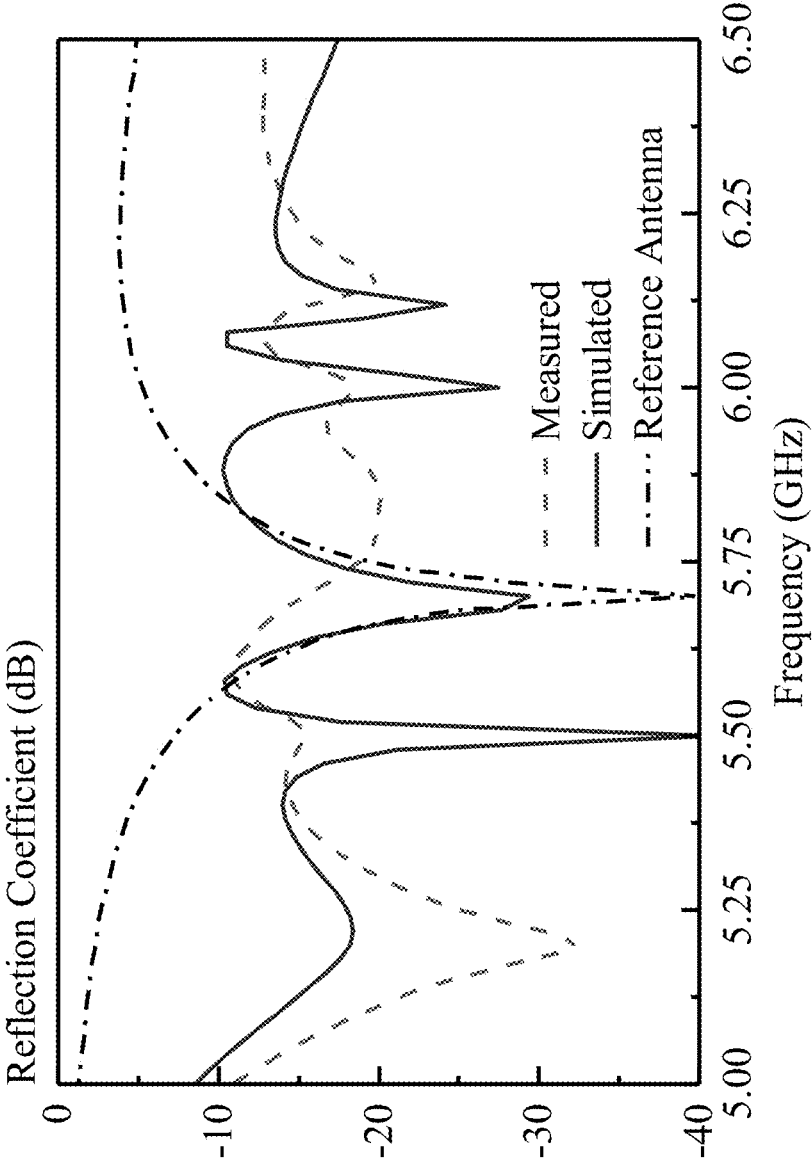


Figure 5

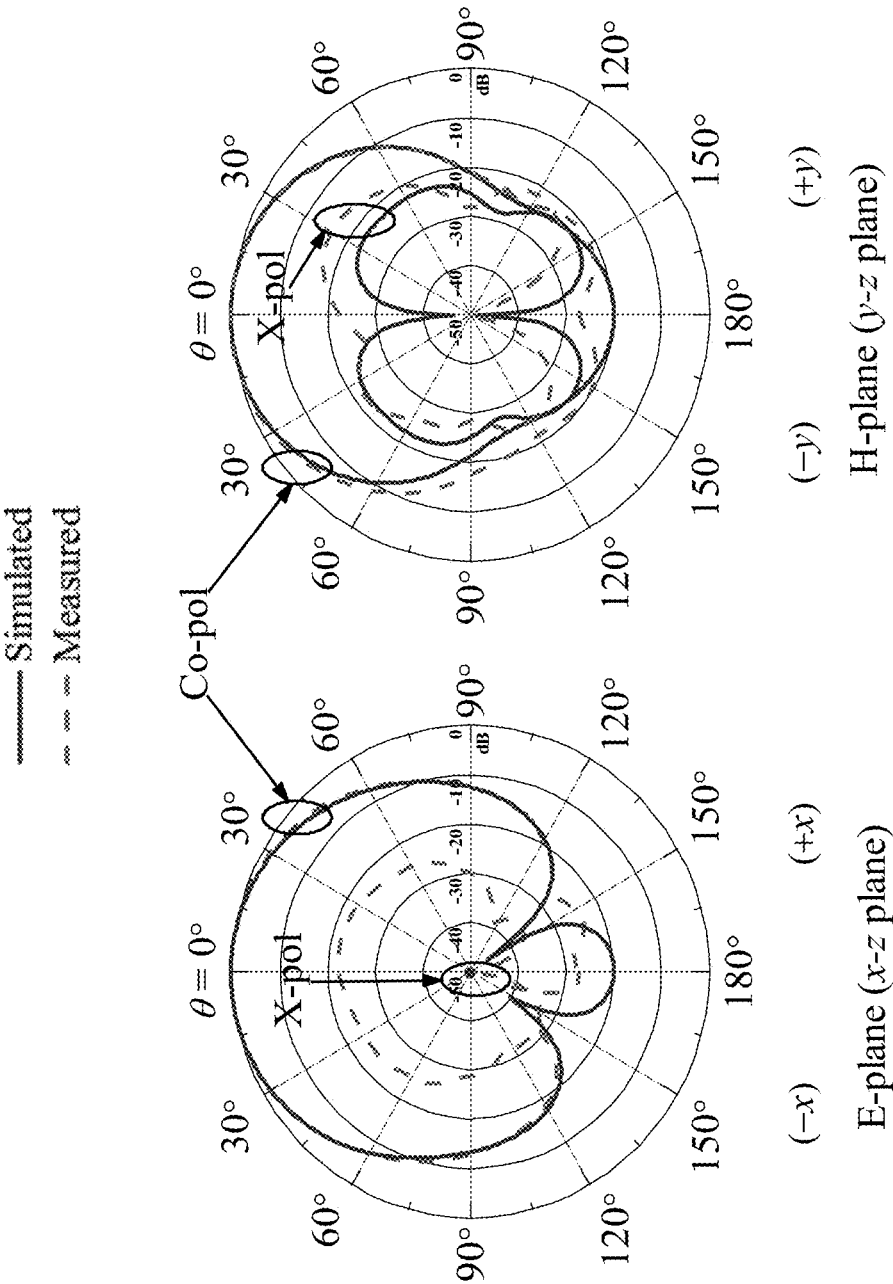


Figure 6A

Figure 6B

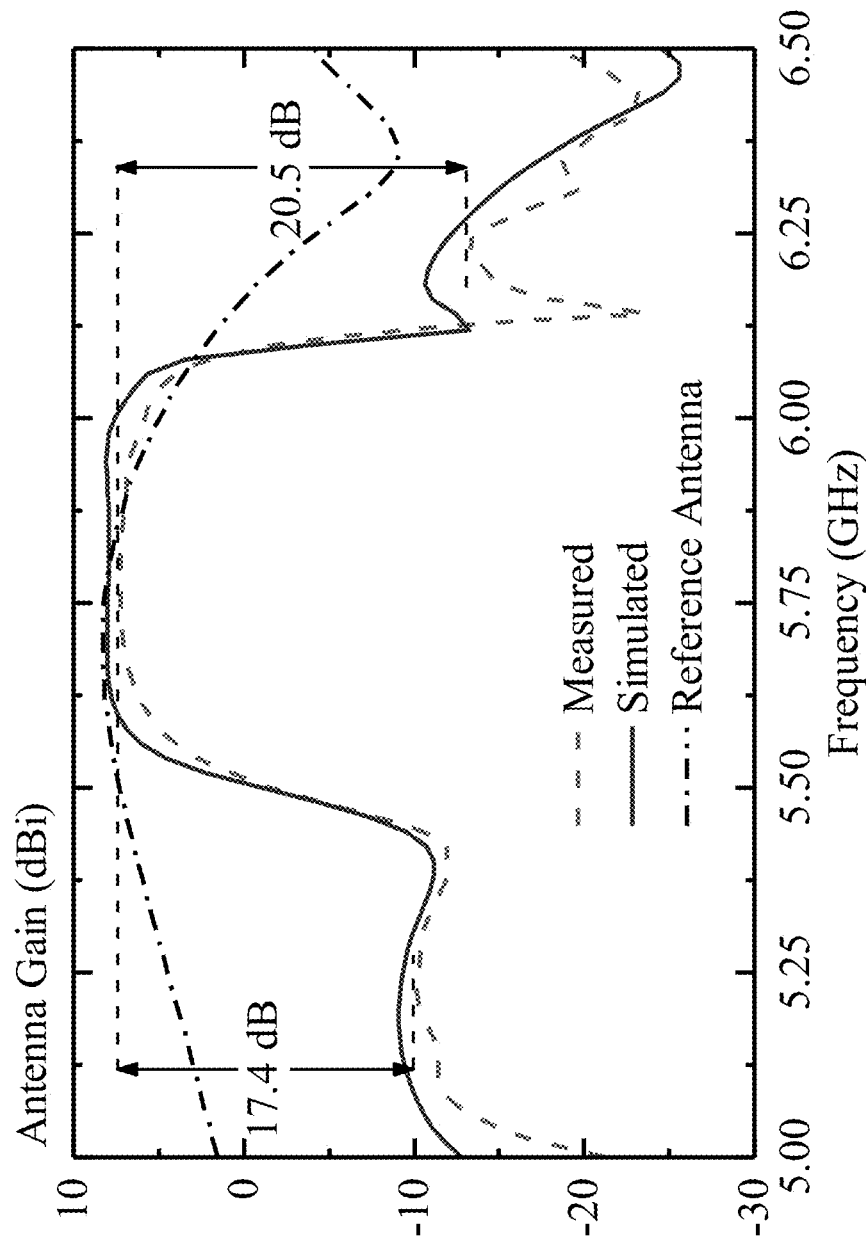


Figure 7

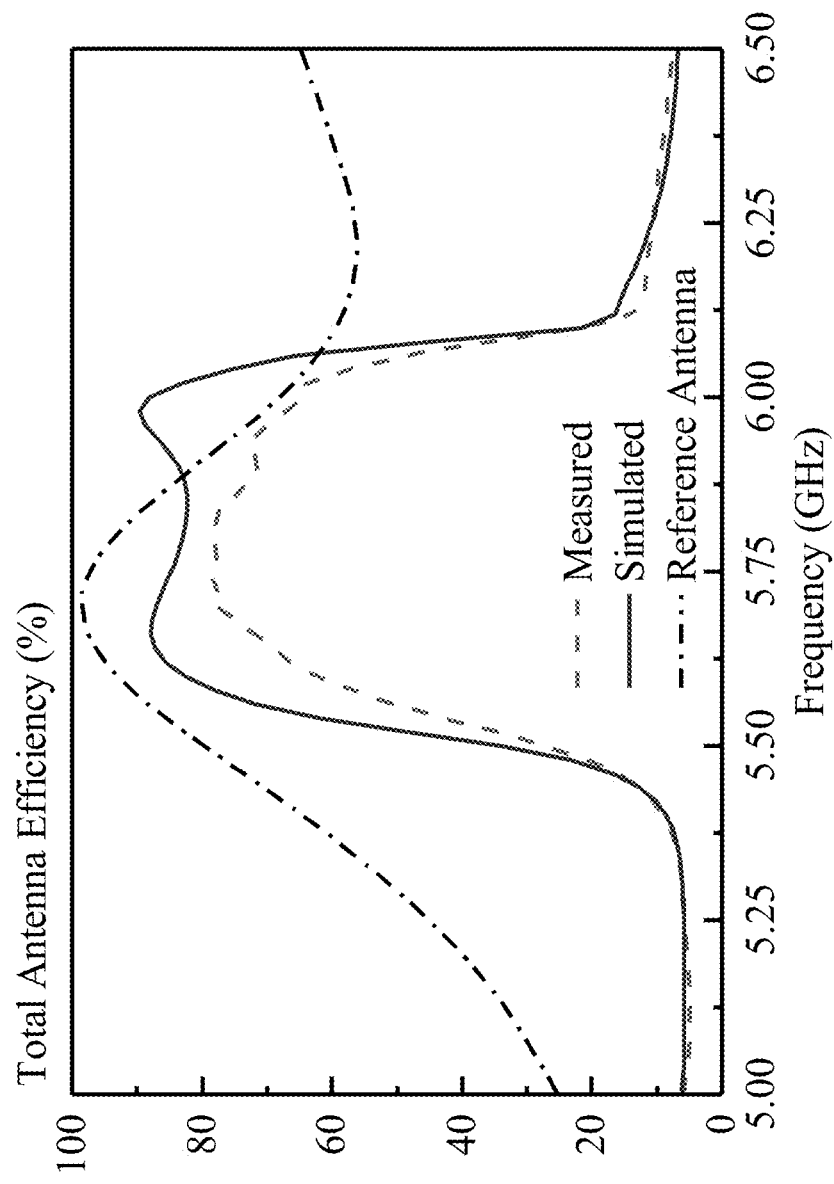


Figure 8

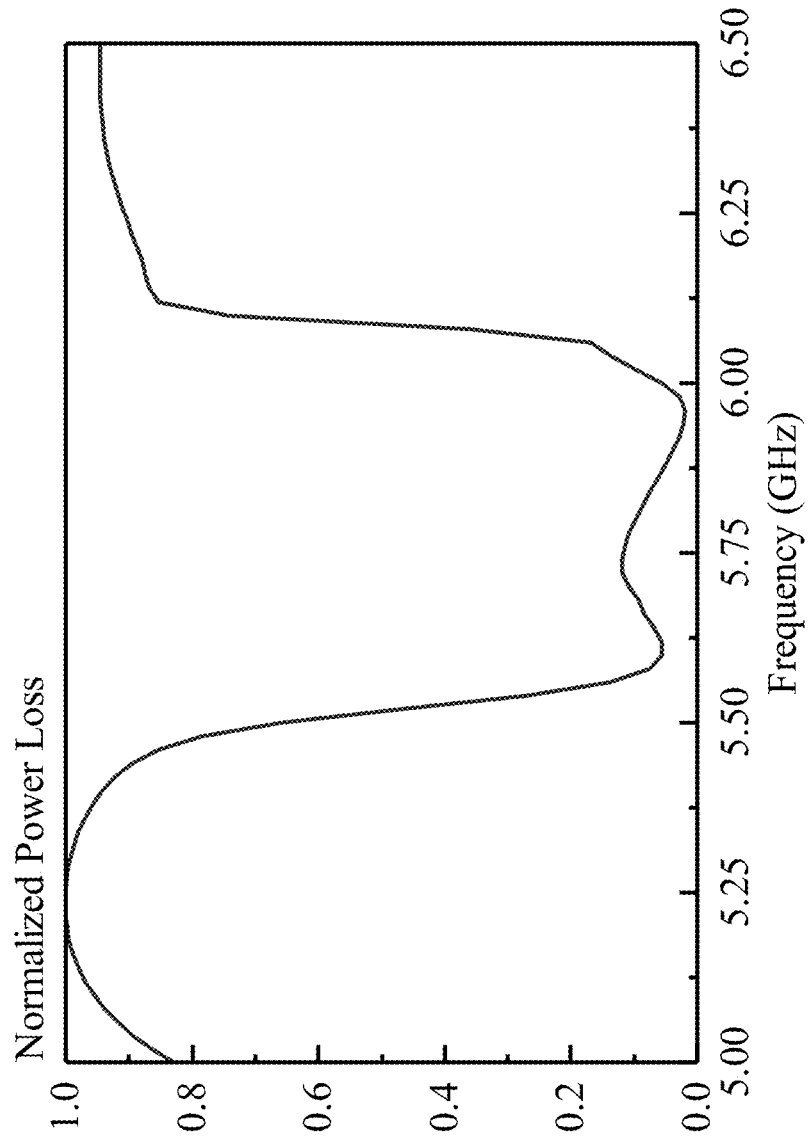


Figure 9

FILTER-ANTENNA AND METHOD FOR MAKING THE SAME

TECHNICAL FIELD

[0001] The invention relates to a filter-antenna and a method for making the filter-antenna. The invention also relates to a communication device that includes the filter-antenna.

BACKGROUND

[0002] Filters and antennas are common and important components in communication devices. A filter-antenna (or filtering-antenna) is a device that combines an antenna and a filter.

[0003] Existing filter-antennas are reflective filter-antennas. These reflective filter-antennas reflect most of the incident energy in the stopband. The reflected energy may be transferred to other components (e.g., a power amplifier associated with the filter-antenna) in the system, which may lead to instability (e.g., self-oscillation in the power amplifier). One option to avoid or mitigate this instability problem is to use isolators, circulators, and/or attenuators in the system to reduce the effect of the reflected energy on the system. However, this option would increase the number of the components in the system, making the system cumbersome and expensive while potentially increasing the insertion loss.

SUMMARY OF THE INVENTION

[0004] In accordance with a first aspect of the invention, there is provided a filter-antenna, comprising a microstrip antenna integrated with an absorptive filter for absorbing or dissipating energy. By absorbing or dissipating the energy, e.g., energy received from an external source, reflection of energy (which may otherwise affect stability of other components/devices) can be prevented, reduced, or eliminated. The filter-antenna can be used for transmission, receiving, or both.

[0005] In one embodiment of the first aspect, the microstrip antenna is a patch antenna. The patch antenna has a relatively low profile.

[0006] In one embodiment of the first aspect, the absorptive filter is a band-stop filter for absorbing or dissipating stopband energy.

[0007] In one embodiment of the first aspect, the microstrip antenna includes a substrate, a ground plane arranged a first face of the substrate, and a microstrip network arranged on a second, opposite face of the substrate. The microstrip antenna may include further layers or components. The absorptive filter includes a filter element at least partly arranged inside the substrate. Preferably, the filter element is arranged substantially completely inside the substrate.

[0008] In one embodiment of the first aspect, the filter element comprises a resistor. The resistor may be a chip resistor.

[0009] In one embodiment of the first aspect, the absorptive filter further comprises: a defected microstrip structure arranged in the microstrip network and a defected ground structure arranged in the ground plane. The defected microstrip structure and the defected ground structure are operably connected with the filter element.

[0010] In one embodiment of the first aspect, the microstrip antenna is a patch antenna and the microstrip network comprises a patch. The patch may be arranged centrally of the substrate.

[0011] In one embodiment of the first aspect, the patch includes a central portion, and the defected microstrip structure comprises one or more slots arranged (e.g., etched) in the central portion of the patch. The slot(s) may be U-shaped. The central portion of the patch may include one or more open stubs each associated with a respective slot. In one example, the patch has two open stubs, e.g., two $\lambda_g/4$ open stubs, where λ_g is the guided wavelength at the center frequency.

[0012] In one embodiment of the first aspect, the patch further includes a first side portion connected with and arranged a first side of the central portion and a second side portion connected with and arranged at a second, opposite side of the central portion. Each of the first and second side portions includes one or more stubs. In one example, each of the first and second side portions includes a dual-stub or a dual-stub feed. The stubs in the dual stub or dual stub feed can be of different lengths.

[0013] In one embodiment of the first aspect, the patch is symmetric about an axis of symmetry. The central portion of the patch may also be symmetric about the axis of symmetry.

[0014] In one embodiment of the first aspect, the defected ground structure comprises one or more slots (e.g., etched) arranged in the ground plane. The defected ground structure may comprise a central slot corresponding to the central portion of the patch. The central slot may be U-shaped. In plan view, the central slot may overlap with the central portion of the patch.

[0015] The defected ground structure may further comprise a first side slot arranged on a first side of the central slot and a second side slot arranged on a second, opposite side of the central slot. The first and second side slots are arranged to assist in absorbing or dissipating the energy. The first and second side slots can be symmetrically disposed about the axis of symmetry. The first and second side slots may have the same shape and size. The first and second side slots may be a generally-q shaped.

[0016] In one embodiment of the first aspect, the microstrip network further comprises one or more parasitic patches operably connected with the patch. The one or more parasitic patches may be spaced apart from the patch. The one or more parasitic patches may comprise two parasitic patches arranged at opposite sides of the patch. The two parasitic patches may be slotted patches each having one or more slots. In one example, the slot is rectangular. The two parasitic patches may be equally spaced apart from the patch and symmetrically disposed about the patch.

[0017] In one embodiment of the first aspect, the patch antenna has a coaxial feed that extends through the substrate and connects with the patch. In one example, the coaxial feed is connected at one end of the patch and the filter element is connected at another end of the patch. The coaxial feed may extend perpendicular to the face of the substrate.

[0018] In a second aspect of the invention, there is provided a communication device comprising the filter-antenna of the first aspect. The communication device may be a wireless communication device. The communication device may be part of a communication system.

[0019] In a third aspect of the invention, there is provided a method for making a filter-antenna, comprising forming a

microstrip antenna integrated with an absorptive filter for absorbing or dissipating energy. The forming includes forming a microstrip antenna; and integrating, in the microstrip antenna, an absorptive filter for absorbing or dissipating energy. The two steps can be performed simultaneously.

[0020] In one embodiment of the third aspect, forming the microstrip antenna comprises forming a patch antenna.

[0021] In one embodiment of the third aspect, forming the microstrip antenna comprises forming a microstrip network on a first face of a substrate of the microstrip antenna.

[0022] In one embodiment of the third aspect, forming the microstrip antenna further comprises forming a defected microstrip structure in the microstrip network.

[0023] In one embodiment of the third aspect, forming the microstrip antenna further comprises forming a defected ground structure on a ground plane on a second, opposite face of the microstrip antenna.

[0024] In one embodiment of the third aspect, integrating the absorptive filter comprises forming a hole in the substrate for receiving a filter element of the absorptive filter. Integrating the absorptive filter may further include arranging the filter element of the absorptive filter in the hole.

[0025] In one embodiment of the third aspect, arranging the filter element of the absorptive filter in the hole comprises arranging the filter element of the absorptive filter arranged substantially completely in the hole.

[0026] In one embodiment of the third aspect, the method further comprises forming an electric connection between the filter element and the ground plane and an electric connection between the filter element and the microstrip network. Forming the electric connection may include welding or soldering.

[0027] In one embodiment of the third aspect, the filter element comprises a resistor. The resistor may be a chip resistor.

BRIEF DESCRIPTION OF THE DRAWINGS

[0028] Embodiments of the invention will now be described, by way of example, with reference to the accompanying drawings in which:

[0029] FIG. 1 is a schematic diagram showing a filter-antenna in one embodiment of the invention;

[0030] FIG. 2A is a top view of a filter-antenna in one embodiment of the invention;

[0031] FIG. 2B is an enlarged view of a patch in the filter-antenna of FIG. 2A;

[0032] FIG. 2C is a side view of the filter-antenna of FIG. 2A;

[0033] FIG. 2D is a bottom view of the filter-antenna of FIG. 2A;

[0034] FIG. 3 is a flow chart illustrating a method for making a filter-antenna in one embodiment of the invention;

[0035] FIG. 4A is a picture showing a top surface of a filter-antenna in one embodiment of the invention;

[0036] FIG. 4B is a picture showing a bottom surface of the filter-antenna of FIG. 3A;

[0037] FIG. 5 is a graph showing measured and simulated reflection coefficients of the filter-antenna of FIG. 4A and reflection coefficient of a reference antenna;

[0038] FIG. 6A is a graph showing measured and simulated radiation patterns of the filter-antenna of FIG. 4A in the E-plane (x-z plane) at 5.8 GHz;

[0039] FIG. 6B is a graph showing measured and simulated radiation patterns of the filter-antenna of FIG. 4A in the H-plane (y-z plane) at 5.8 GHz;

[0040] FIG. 7 is a graph showing measured and simulated gain of the filter-antenna of FIG. 3A and gain of a reference antenna;

[0041] FIG. 8 is a graph showing measured and simulated total antenna efficiency of the filter-antenna of FIG. 4A and total antenna efficiency of a reference antenna; and

[0042] FIG. 9 is a graph showing simulated power loss (normalized with respect to its maximum at 5.24 GHz) in the chip resistor in the filter-antenna of FIG. 2A.

DETAILED DESCRIPTION

[0043] FIG. 1 is a schematic of a filter-antenna **20** in one embodiment of the invention. The filter-antenna **20** is operably connected with a signal (e.g., energy) source **10** such as a power amplifier to receive a signal (e.g., energy) from the signal source **10**. The filter-antenna **20** includes a bandpass channel **22BP** and a band-stop channel **22BS**. The bandpass channel **22BP** is connected with an antenna element **24**. The band-stop channel **22BS** is connected with a filter element **26** illustrated as a resistor. The energy in the passband received at the bandpass channel **22BP** is transmitted to the antenna element **24**; the energy in the stopband received at the band-stop channel **22BS** is absorbed or dissipated by the resistor **26**. Thus, the energy reflection in both the passband and the stopband is reduced, minimized, and preferably substantially eliminated, to avoid possible detrimental effects on neighboring components (e.g., the power amplifier).

[0044] FIGS. 2A to 2D illustrate a filter-antenna **200** in one embodiment of the invention. The filter-antenna **200** generally includes a microstrip antenna integrated with an absorptive filter for absorbing or dissipating energy. In this embodiment, the microstrip antenna is a patch antenna and the absorptive filter is a band-stop filter for absorbing or dissipating stopband energy.

[0045] As shown in FIGS. 2A to 2D, the filter-antenna **200** includes a substrate **202**, a patch network **204** formed by conductive patches on an upper face of the substrate **202**, and a ground plane **206** formed by a conductive surface on a lower face of the substrate **202**. The substrate **202** has a dielectric constant ϵ_{rs} . The substrate **202** has a thickness (in z-direction) t , and an area (in x-y plane) of $G \times G$. A coaxial connector or feed connector **208**, with an inner cable of radius r_1 , is attached to the lower surface of the substrate **202** and penetrates through the substrate **202** to connect with a patch **204A** of the patch network **204**. The cable feed **208** is soldered to the patch **204A** for exciting the filter-antenna **200**.

[0046] As best shown in FIGS. 2A and 2B, the patch network **204** includes a main patch **204A** and two side patches **204B**, **204C** arranged on respective sides of the main patch **204A**. The main patch **204A** includes a central portion **204A1** and two side portions **204A2**, **204A3** arranged on two sides of the central portion **204A1**. The central portion **204A1** includes two generally U-shaped slots **220** disposed symmetrically about an axis of symmetry (in x-direction) of the main patch **204A**. Each of the U-shaped slots **220** is associated with a respective open stub (surrounded by a dotted loop near **220**), a $\lambda_g/4$ open stub (λ_g is the guided wavelength). Each of the side portions **204A2**, **204A3** include a dual-stub or a dual-stub feed **222**. Each dual stub

feed **222** include stubs of lengths of L_6 and L_7 ($L_6 > L_7$) separated by width W_5 . The two stubs have the same width of W_6 . The central portion **204A1** is connected with the feed **208** at one end and with a resistor element **214** in the other end.

[0047] The two side patches **204B**, **204C** are parasitic slotted patches. Each of the patches **204B**, **204C** is generally rectangular and includes a rectangular slot. The two side patches **204B**, **204C** are symmetrically disposed about the axis of symmetry (in x-direction) of the main patch **204A**. The two side patches **204B**, **204C** are also aligned with the main patch **204A** in that their top edges (in the x-direction) are on the same level and their bottom edges (in the x-direction) are on the same level. Each of the slotted patches **204B**, **204C** has a length of L_a and width of W_a , and is respectively spaced apart from the edge of the main patch **204A** by a distance S_1 . The rectangular slot has a length of L_p and width of W_{p1} .

[0048] FIG. 2D shows the ground plane **206**. The ground plane **206** is generally a flat conductive surface with three slots. At the center of the ground plane **206**, which, in plan view, correspond to the main patch **204A** is a U-shaped slot, a $\lambda_g/2$ U-shaped slot **230** formed (e.g., etched) in the ground plane **206**. Two generally-η shaped side slots **232** are arranged on two sides of the U-shaped slot **230** to improve the suppression level of the lower stopband.

[0049] FIG. 2C shows the filter element **214** at least partly arranged inside the substrate **202**. In this embodiment, the filter element **214** is a chip resistor embedded in the substrate **202** (a small hole formed in the substrate **202**) for absorbing or dissipating stopband energy. The chip resistor has a resistance of 47Ω . One end of the chip filter is soldered to the main patch **204A** whereas the other end of the chip filter is soldered to the ground plane **206**.

arranged in the central portion **204A1**. The defected ground structure includes the slots **230**, **232** formed in the ground plane **206**. The filter can be considered as a resistor-terminated band-stop filter (BSF) **210**.

[0051] FIG. 3 shows a method **300** for making a filter-antenna in one embodiment of the invention. The filter-antenna could be the one in FIGS. 2A to 2D. The method **300** includes, in step **302**, forming a microstrip antenna, and in step **304**, integrating, in the microstrip antenna, an absorptive filter for absorbing or dissipating energy. The two steps **302**, **304** may be carried out in the order stated, or simultaneously. The microstrip antenna may be a patch antenna. In one example, forming the microstrip antenna includes processing a PCB substrate (substrate+metallic layers on opposite faces of the substrate). Specifically forming the microstrip antenna may include forming a microstrip network on a first face of a substrate of the microstrip antenna, forming a defected microstrip structure in the microstrip network, and/or forming a defected ground structure on a ground plane on a second, opposite face of the microstrip antenna. The absorptive filter may be integrated in the substrate by forming (e.g., drilling) a hole in the substrate, then arranging the filter element in the hole. The filter element of the absorptive filter can be arranged substantially completely in the hole. Electric connections between the filter element and the ground plane may be formed by soldering or welding. Likewise, Electric connections between the filter element and the microstrip network may be formed by soldering or welding.

[0052] FIGS. 4A and 4B show the prototype **400** of a filter-antenna fabricated based on the filter-antenna **200** of FIGS. 2A to 2D. Dimensions of the prototype **400** are listed in the following table.

TABLE I

DIMENSIONS OF THE FILTER-ANTENNA PROTOTYPE						
L_a	W_a	L_p	W_{p1}	W_{p2}	S_1	S_2
15.9 mm	9.4 mm	7.2 mm	2.4 mm	1.4 mm	1.3 mm	12.95 mm
S_3	S_4	S_5	S_6	S_7	r_1	r_2
2.55 mm	0.75 mm	1.65 mm	1.2 mm	0.9 mm	0.48 mm	1.8 mm
r_3	L_1	L_2	L_3	L_4	L_5	L_6
0.75 mm	0.7 mm	2.15 mm	9.95 mm	9.8 mm	2.7 mm	11.6 mm
L_7	L_8	L_9	W_1	W_2	W_3	W_4
8.1 mm	2 mm	2.65 mm	0.15 mm	4 mm	1.1 mm	0.4 mm
W_5	W_6	W_7	L_{g1}	L_{g2}	L_{g3}	L_{g4}
0.5 mm	0.4 mm	0.8 mm	10.4 mm	3 mm	12.5 mm	2.1 mm
L_{g5}	W_{g1}	W_{g2}	H	G	t	ϵ_{rs}
8.9 mm	0.2 mm	0.15 mm	30 mm	40 mm	1.575 mm	2.33

[0050] The filter-antenna **200** of FIGS. 2A to 2D includes a filter integrated into the patch antenna. The filter is formed by a defected microstrip structure arranged in the microstrip network **204**, the chip resistor **214**, and a defected ground structure arranged in the ground plane **206**. The defected microstrip structure includes the stubs and slots **220**

[0053] Experiments and simulations had been performed to verify the performance of the filter-antenna **400**. The experiments performed includes measuring reflection coefficient using an Agilent™ 8753ES vector network analyzer, and measuring radiation pattern, antenna gain, and antenna efficiency using a Satimo™ StarLab System.

[0054] FIG. 5 shows the measured and simulated reflection coefficients of the filter-antenna 400 and reflection coefficient of a reference antenna. As shown in FIG. 5, the measured result generally agrees with the simulated result. The measured reflection coefficient is below -10 dB over the entire frequency range (5-6.5 GHz). This demonstrates the reflection-less characteristic of the filter-antenna 400. It is noted that the reflection coefficient of the filter-antenna 400 does not have a sharp selectivity. For comparison, a conventional rectangular patch antenna having the same length of L_a and width of W_r is included here as the reference antenna. Its simulated reflection coefficient is also shown in FIG. 5. It can be seen from FIG. 5 that the impedance bandwidth of the reference antenna is much narrower than that of the filter-antenna 400 although the reference antenna and filter-antenna 400 have the same patch size.

[0055] FIGS. 6A and 6B show the measured and simulated normalized radiation patterns at 5.8 GHz. As shown in FIGS. 6A and 6B, the maximum co-polar field is found in the boresight direction ($\theta=0^\circ$). It is stronger than its cross-polar counterpart by more than 22 dB. The measured H-plane radiation pattern (yz-plane, $\phi=90^\circ$) is not symmetric although the filter-antenna 400 is symmetric about the xz-plane. This may be caused by experimental imperfections including assembly errors. It was found that the radiation patterns are stable over the targeted ISM band (5725-5.875 GHz) (results not illustrated).

[0056] FIG. 7 shows the measured and simulated realized antenna gains in the boresight direction ($\theta=0^\circ$). With reference to FIG. 7, the measured and simulated results are in good agreement. The measured maximum realized gain is 7.28 dBi at 5.8 GHz, which is 0.78 dB lower than the simulated peak gain (8.06 dBi) at 5.94 GHz due to experimental tolerances. The measured realized antenna gain is higher than 7 dBi from 5.725 to 5.875 GHz, with a measured 1-dB gain bandwidth (gain \geq 6.28 dBi) of 5.86% (5.63-5.97 GHz). In the upper stopband, two measured radiation nulls with low antenna gains of around -23.5 dBi, along with a sharp roll-off rate for the upper band-edge, are observed. The measured out-of-band suppression level is more than 20.5 dB in the upper stopband (6.12-6.50 GHz). In the lower stopband (5.00-5.44 GHz), another two radiation nulls are measured at 5.41 GHz and below 5.0 GHz, respectively, leading to a suppression level of more than 17.4 dB. The antenna gain of the reference antenna is also shown in the same figure to highlight the filtering characteristic of the filter-antenna 400 of the above embodiment.

[0057] FIG. 8 shows the measured and simulated total antenna efficiency (mismatch included) of the filter-antenna 400. With reference to FIG. 8, the measured efficiency is higher than 72.5% from 5.725 to 5.875 GHz, with a maximum of 78.5% at 5.74 GHz. The simulated peak efficiency is 89.7% at 5.98 GHz. The efficiency decreases rapidly on the band-edge and then becomes small in the stopbands, giving a sharp selectivity. Since the antenna 200, 400 is matched across the entire band (5-6.5 GHz), it can be inferred that the energy is mostly dissipated in the chip resistor in the antenna stopbands. This illustrates that a well-matched antenna does not necessarily radiate effectively. Again, the simulated result of the reference patch antenna is included in FIG. 8. As expected, the reference patch antenna does not have any sharp filtering response.

[0058] The simulated power loss in the chip resistor is shown in FIG. 9. The results in FIG. 9 have been normalized

with respect to the maximum at 5.24 GHz. With reference to FIG. 9, the normalized power loss is lower than 0.12 in the 1-dB gain passband (5.63-5.97 GHz) and higher than 0.85 in the stopbands (5.00-5.44 GHz and 6.12-6.50 GHz) with sharp band-edge selectivity. It should be noted that the frequency response of the normalized power loss in FIG. 9 is almost complementary to that of the simulated efficiency in FIG. 8. This suggests that the band-stop filter and the filtering patch antenna have generally-complementary transfer functions, which are required to reduce or eliminate reflection.

[0059] The above embodiments of the invention have generally provided a filter-antenna that can effectively reduce reflection of energy, in particular energy in the stopband. The filter-antenna is compact, low-profile, and small, and is suitable for miniature communication devices and systems. The above embodiments of the invention can be used in the wireless transmitter to reduce the system size and loss. The filter-antenna in the above embodiment has four radiation nulls that can be tuned independently to facilitate the design. A resistor-terminated band-stop filter is embedded at the center of the patch antenna to absorb the energy in the stopbands. The band-stop filter consists of a defected ground structure, a defected microstrip structure, along with the chip resistor. Good impedance matching is achieved in the passband and in the stopband.

[0060] The filter-antenna in the above embodiments may reduce, avoid, or prevent the energy in the stopband from reflecting back to the source or other components, by absorbing or dissipating the energy through a filter (esp., resistor). The energy in the passband is transmitted to the antenna, whereas the energy in the stopbands is absorbed by the filter (esp., resistor). As a result, the energy reflection is greatly reduced or even eliminated in both the passband and stopbands, which avoid possible detrimental effects on the source or other components.

[0061] It will be appreciated by person skilled in the art that numerous variations and/or modifications may be made to the invention as shown in the specific embodiments without departing from the spirit or scope of the invention as broadly described. The described embodiments of the invention should therefore be considered in all respects as illustrative, not restrictive.

[0062] For example, the filter-antenna need not be a patch antenna but can be other forms of microstrip antennas. The substrate of the antenna can be formed by one or more substrate layers, of the same or different dielectric constants (ϵ_r). The dielectric constant of the substrate layer can vary. The shape, form, and size of the substrate; the shape, form, and size of the ground plane; and the shape, form, and size of the microstrip network or patch network can be different. The patch network can have any number of (at least one) patches with any of shape and form. The patch(es) need not necessarily be arranged symmetrically. The patches could form an array to give an array antenna (integrated with filter). The feed of the antenna can be non-coaxial feed, such as microstrip feed. The feed need not be perpendicular to the face of the substrate, but can be parallel or at any other angles to the face of the substrate. The filter-antenna can be made with different form factors. The filter-antenna can be used for other radio frequencies (e.g., microwave) not specifically mentioned above.

1. A filter-antenna, comprising:
a microstrip antenna integrated with an absorptive filter for absorbing or dissipating energy.
2. The filter-antenna of claim 1, wherein the microstrip antenna is a patch antenna.
3. The filter-antenna of claim 1, wherein the absorptive filter is a band-stop filter for absorbing or dissipating stopband energy.
4. The filter-antenna of claim 1, wherein the microstrip antenna includes
a substrate,
a ground plane arranged a first face of the substrate, and
a microstrip network arranged on a second, opposite face of the substrate; and
wherein the absorptive filter includes a filter element at least partly arranged inside the substrate.
5. The filter-antenna of claim 4, wherein the filter element is arranged substantially completely inside the substrate.
6. The filter-antenna of claim 5, wherein the filter element comprises a resistor.
7. The filter-antenna of claim 6, wherein the filter element comprises a chip resistor.
8. The filter-antenna of claim 4, wherein the absorptive filter further comprises:
a defected microstrip structure arranged in the microstrip network and
a defected ground structure arranged in the ground plane;
wherein the defected microstrip structure and the defected ground structure are operably connected with the filter element.
9. The filter-antenna of claim 8, wherein the microstrip antenna is a patch antenna and the microstrip network comprises a patch.
10. The filter-antenna of claim 9, wherein the patch includes a central portion, and the defected microstrip structure comprises one or more slots arranged in the central portion of the patch.
11. The filter-antenna of claim 10, wherein the central portion of the patch includes one or more open stubs each associated with a respective slot.
12. The filter-antenna of claim 11, wherein the patch further includes a first side portion connected with and arranged a first side of the central portion and a second side portion connected with and arranged at a second, opposite side of the central portion, and wherein each of the first and second side portions includes one or more stubs.
13. The filter-antenna of claim 9, wherein the patch is symmetric about an axis of symmetry.
14. The filter-antenna of claim 11, wherein the defected ground structure comprises one or more slots arranged in the ground plane.
15. The filter-antenna of claim 14, wherein the defected ground structure comprises a central slot corresponding to the central portion of the patch.
16. The filter-antenna of claim 15, wherein the defected ground structure further comprises a first side slot arranged on a first side of the central slot and a second side slot arranged on a second, opposite side of the central slot.

17. The filter-antenna of claim 9, wherein the microstrip network further comprises one or more parasitic patches operably connected with the patch.

18. The filter-antenna of claim 17, wherein the one or more parasitic patches are spaced apart from the patch.

19. The filter-antenna of claim 18, wherein the one or more parasitic patches comprises two parasitic patches arranged at opposite sides of the patch.

20. The filter-antenna of claim 19, wherein the two parasitic patches are slotted patches.

21. The filter-antenna of claim 20, wherein the two parasitic patches are equally spaced apart from the patch and symmetrically disposed about the patch.

22. The filter-antenna of claim 9, wherein the patch antenna has a coaxial feed that extends through the substrate and connects with the patch.

23. The filter-antenna of claim 22, wherein the coaxial feed is connected at one end of the patch and the filter element is connected at another end of the patch.

24. A communication device comprising the filter-antenna of claim 1.

25. A method for making a filter-antenna, comprising:
forming a microstrip antenna integrated with an absorptive filter for absorbing or dissipating energy, comprising:
forming a microstrip antenna; and
integrating, in the microstrip antenna, an absorptive filter for absorbing or dissipating energy.

26. The method of claim 25, wherein forming the microstrip antenna comprises:
forming a patch antenna.

27. The method of claim 25, wherein forming the microstrip antenna comprises:
forming a microstrip network on a first face of a substrate of the microstrip antenna.

28. The method of claim 27, wherein forming the microstrip antenna further comprises:
forming a defected microstrip structure in the microstrip network.

29. The method of claim 28, wherein forming the microstrip antenna further comprises:
forming a defected ground structure on a ground plane on a second, opposite face of the microstrip antenna.

30. The method of claim 29, wherein integrating the absorptive filter comprises:
forming a hole in the substrate for receiving a filter element of the absorptive filter.

31. The method of claim 30, wherein integrating the absorptive filter further comprises:
arranging the filter element of the absorptive filter in the hole.

32. The method of claim 31, wherein arranging the filter element of the absorptive filter in the hole comprises arranging the filter element of the absorptive filter substantially completely in the hole.

33. The method of claim 31, further comprising:
forming an electric connection between the filter element and the ground plane and an electric connection between the filter element and the microstrip network.

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